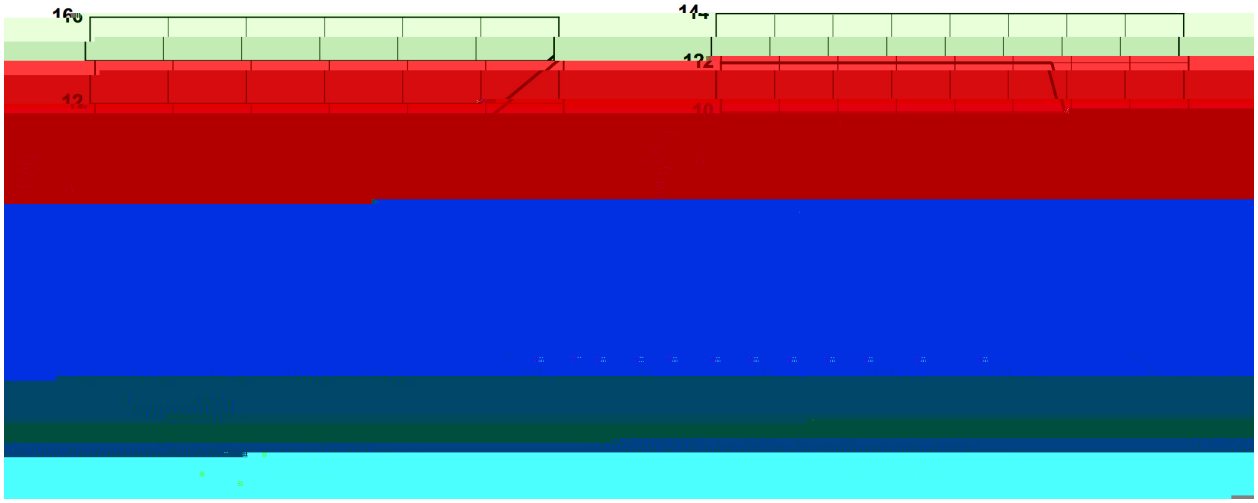
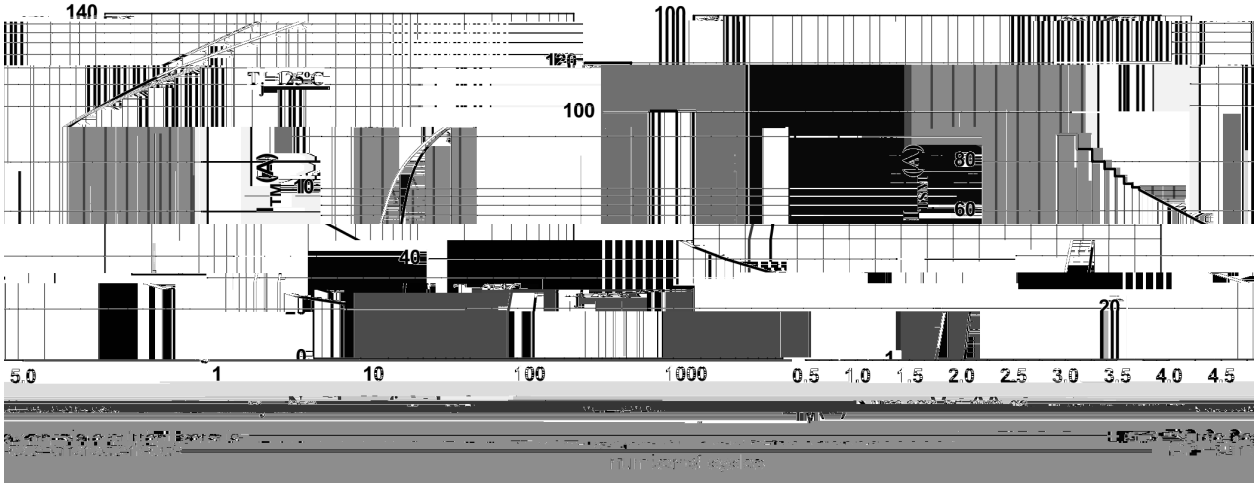
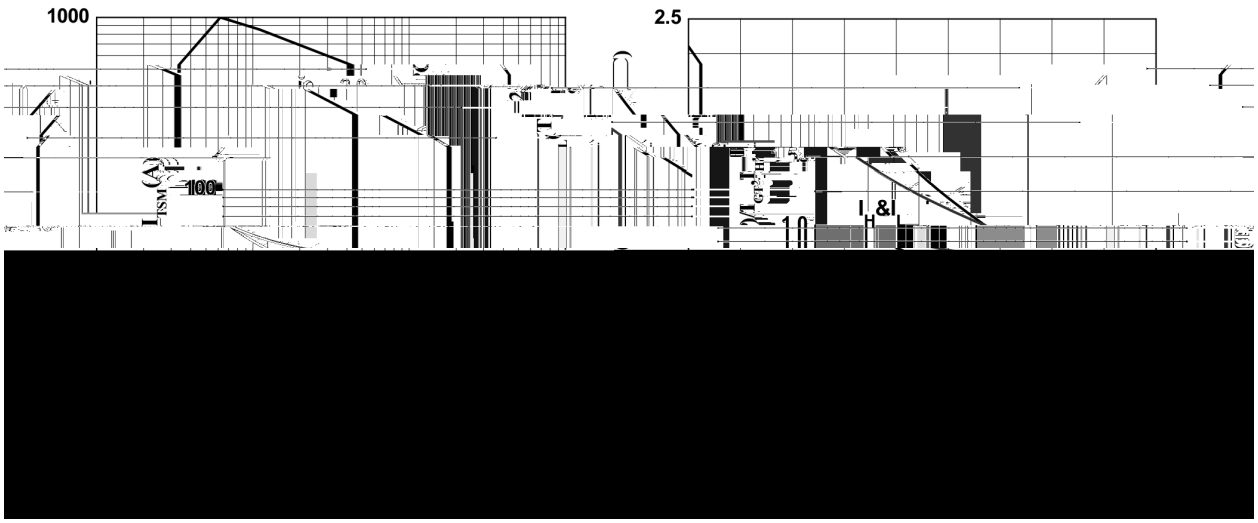
: 5 , .> / / x E g U OJ´ož

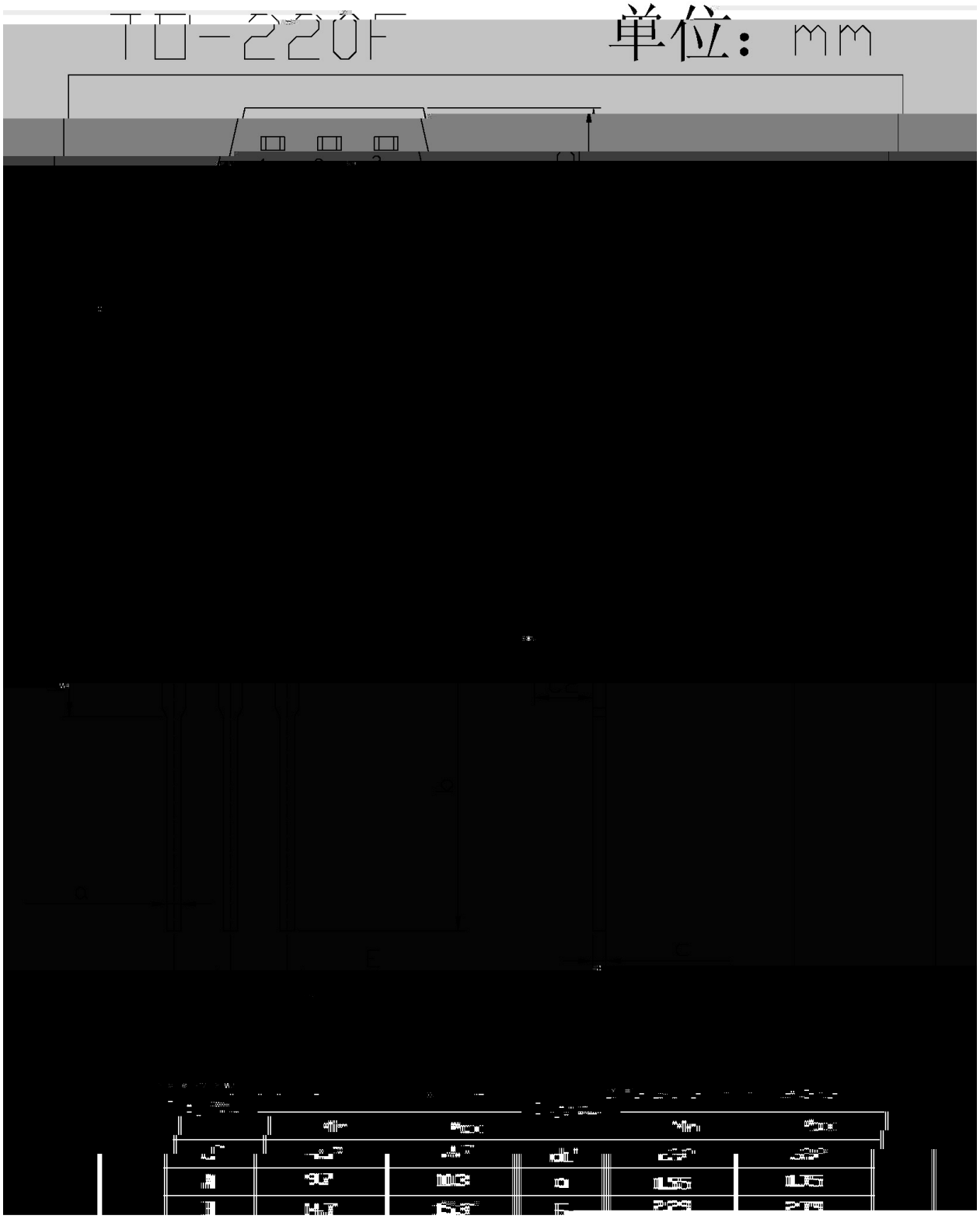
## Ô ? d • Ž ¢ / Electrical Characteristic Curve



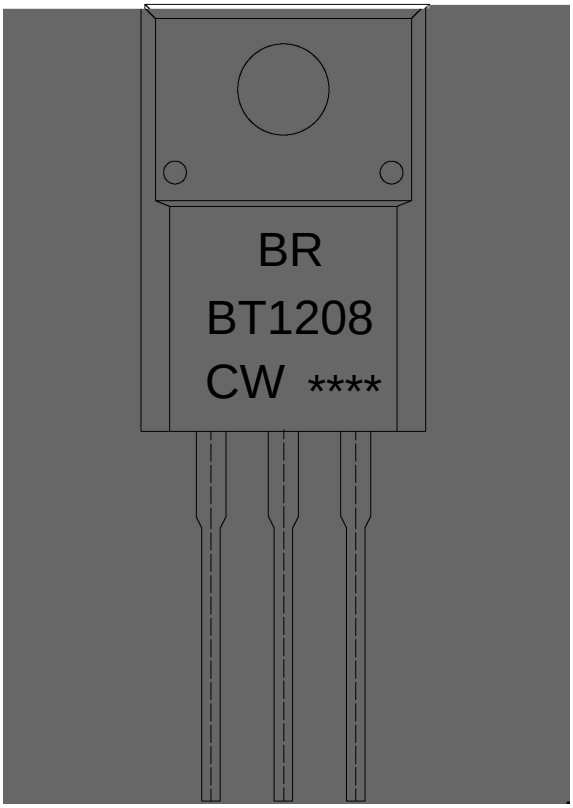


## Ø ¤ = ) ¢ / Package Dimensions



## , M y ƒ / Marking Instructions




ª ¢ y

( 8 y ¸ [ W A

( : y º Z W A

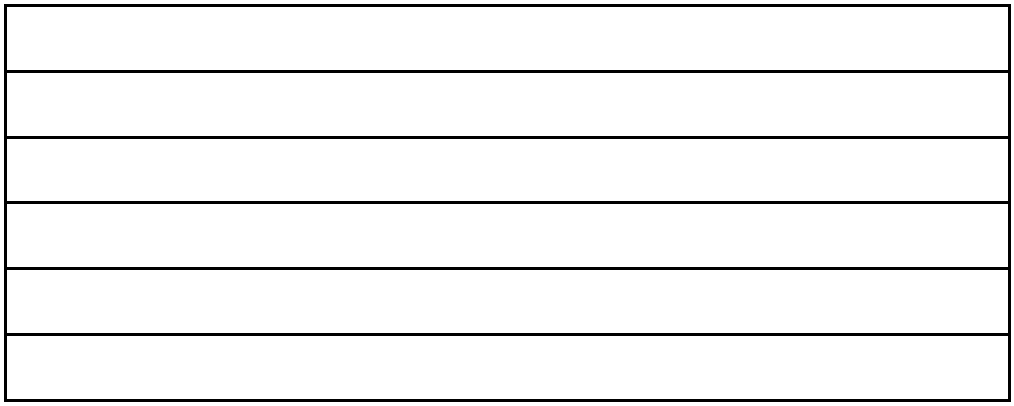
) = y -: ã /W A

y ÿ D Z W A k š ÿ D Z J

Note:

| | |
|---|---|
| BR: | Company Code |
| BT1208: | Product Type Code |
| CW: | $I_{GT}$ Bracket code |
| ****: | Lot No. Code, code change with Lot No |

## G PD t … • Ž ¢ ( x / ) / Temperature Profile for Dip Soldering(Pb-Free)



ª ¢ y

1o• Ä ½ “ † 25 ½150 - k ž • 60 ½90sec;

2o• Q › “ † 255 r5 - k ž • 4 Ò 5 r0.5sec;

3o•D N ò i Ò 0 , † 2 ½10 - /sec.

Note:

1.Preheating:25~150 - , Time:60~90sec.

2.Peak Temp.:255 r5 - , Duration:5 r0.5sec.

3. Cooling Speed: 2~10 - /sec.

## ÂD /Cã p ¯ » ] / Resistance to Soldering Heat Test Conditions

“ † y 270 r5 - ž • y 10 r1 sec. Temp.:270±5 Time:10±1 sec

## G P á / Packaging SPEC.

• ^ x / BULK

| Package Type 7>û ˜ E | Units ;>û ¦H | Dimension ;>û p . |
|---|---|---|